

Discription

The HGBLC05C-LF-T7 protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



SOD-323

Features

- ★ Small Body Outline Dimensions
- ★ Low Body Height
- ★ Peak Power up to 30 Watts @ 8 x 20 _s Pulse
- ★ Low Leakage current
- ★ Response Time is Typically < 1 ns</p>
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ IEC61000-4-4 Level 4 EFT Protection



Circuit Diagram

Ordering Information

Product ID	Pack	Qty(PCS)		
HGBLC05C-LF-T7	SOD-323	3000		

Absolute Ratings(Tamb = 25°C)

W
°C
°C
°C
°C
KV

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

^{1.} FR-5 = 1.0*0.75*0.62 in.



Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.VF = 0.9V at IF = 10mA

V _{RWM} (V)	I _R (uA) @ V _{RWM}	V _{BR} (V)@ I _T (Note 1)	Ι _τ	V _C (V) @ I _{PP} =1 A*	V _C (V) @ Max I _{PP} *	I _{PP} (A)*	P _{PK} (W)*	C (pF)
Max	Max	Min	mA	Тур	Max	Max	Max	Max
5	1.0	5.4	1	9.5	12.9	2	30	2.5

^{*}Surge current waveform per Figure 1.

Typical Characteristics

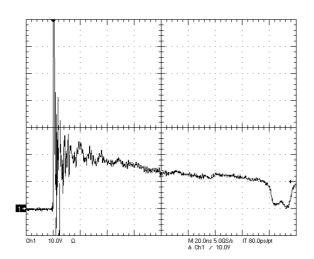


Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV Contact per IEC61000-4-2

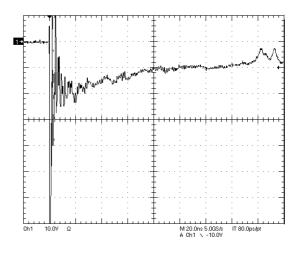


Figure 2. ESD Clamping Voltage Screenshot Negative 8 kV Contact per IEC61000-4-2

IEC 61000-4-2 Spec.

Level	Test Voltage (kV)	First Peak Current (A) Current at 30 ns (A)		Current at 60 ns (A)	
1	2	7.5	4	2	
2	4	15	8	4	
3	6	22.5	12	6	
4	8	30	16	8	

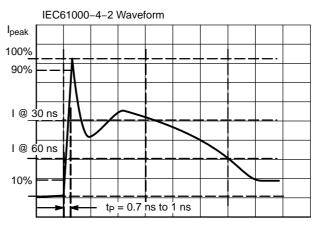
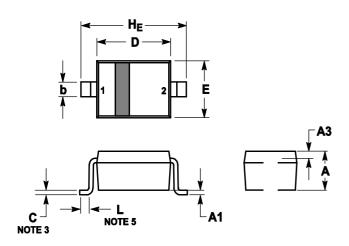


Figure 3. IEC61000-4-2 Spec

^{1.} V_{BR} is measured with a pluse test current I_T at an ambient temperature of 25 $^\circ\!\!\!\!$ C .



OUTLINE AND DIMENSIONS

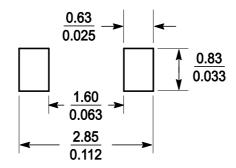


Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.8	0.9	1	0.031	0.035	0.04	
A1	0	0.05	0.1	0	0.002	0.004	
A3	0.15REF			0.006REF			
b	0.25	0.32	0.4	0.01	0.012	0.016	
С	0.089	0.12	0.177	0.003	0.005	0.007	
D	1.6	1.7	1.8	0.062	0.066	0.07	
Е	1.15	1.25	1.35	0.045	0.049	0.053	
L	0.08			0.003			
H _E	2.3	2.5	2.7	0.09	0.098	0.105	

SOLDERING FOOTPRINT



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